

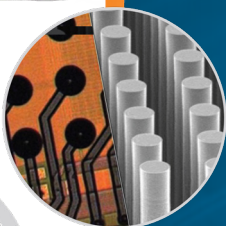


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Microcross Americas
1. 855.426.6766

Microcross EMEA & ROW
+44(0) 1603 788 967

sales@microcross.com

www.microcross.com

Die Distribution & Wafer Processing

Britney Wolfe

britney.wolfe@microcross.com

407.296.5618

Advanced Interconnect Technology

Alan Huffman

alan.huffman@microcross.com

919.248.9216

Packaging & Assembly and Hi-Rel Products

Marcia Terry

marcia.terry@microcross.com

407.296.5705

Component Modification

Robert Martin

robert.martin@microcross.com

267.954.0132

Electrical Test & Environmental Test

Zayd Babamir

zayd.babamir@microcross.com

408.432.1790